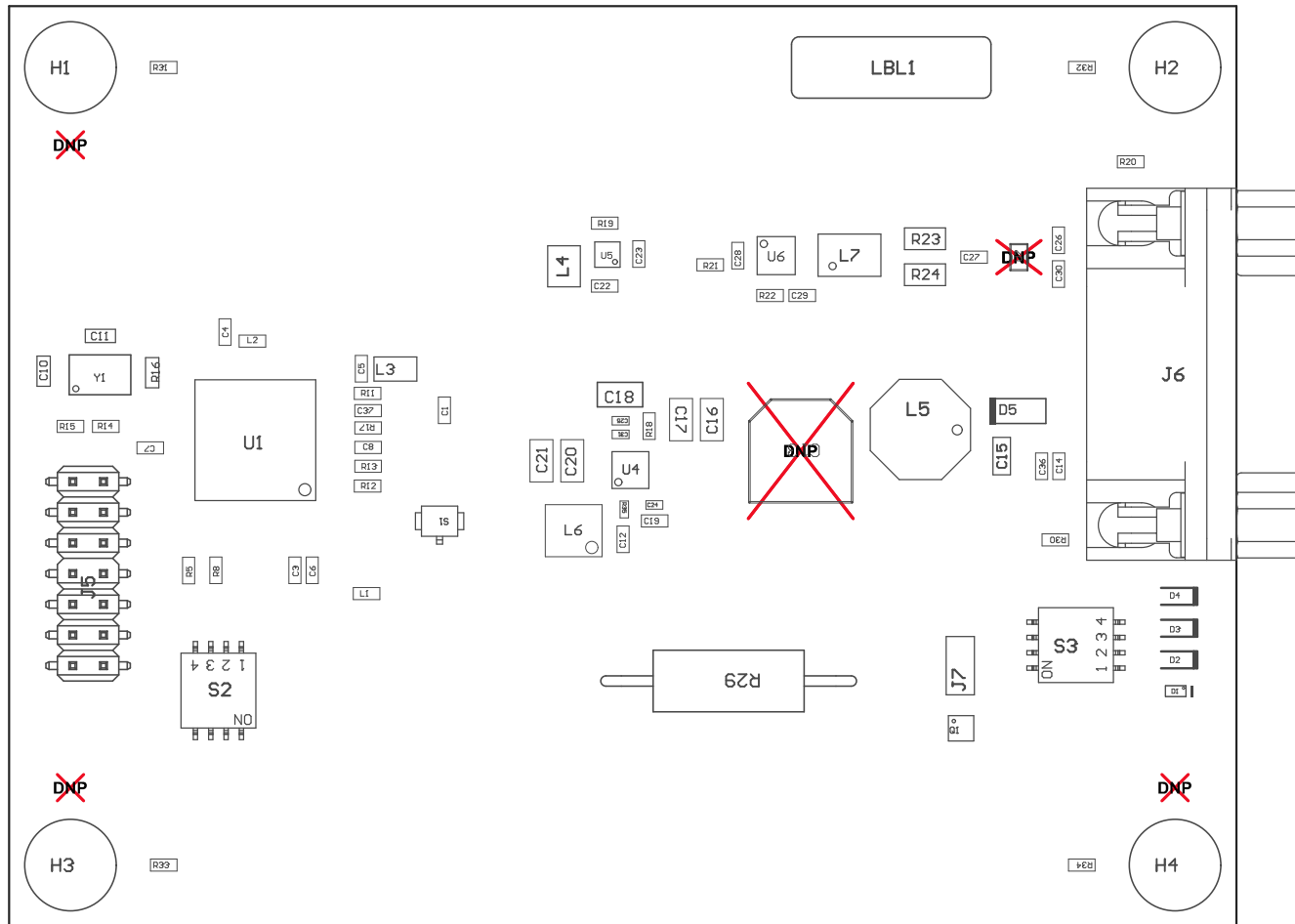
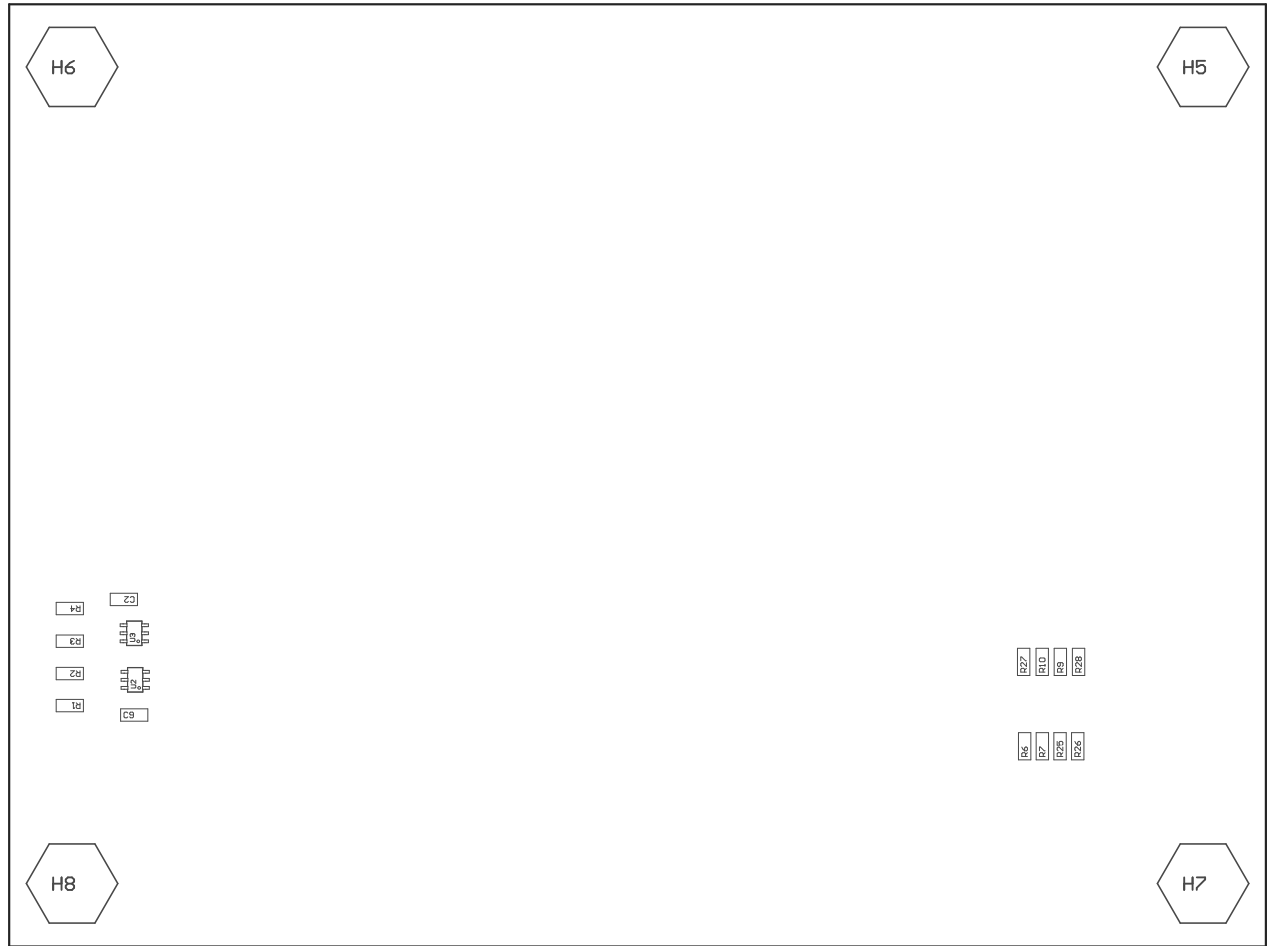


- Z21 ■ Install label in silkscreened box after final wash. Text shall be 8 pt font. Text shall be per the Label Table in the PDF schematic.
- Z22 ■ These assemblies are ESD sensitive, ESD precautions shall be observed.
- Z23 ■ These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.
- Z24 ■ These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.  
 ASSEMBLY VARIANT: 001

|                                  |                       |            |                                |
|----------------------------------|-----------------------|------------|--------------------------------|
| PCB VIEWED FROM TOP SIDE         | BOARD #: TIDA-01428   | REV: E1    | SUN REV: Not In VersionControl |
|                                  | TID #: TIDA-01428     |            |                                |
| PLOT NAME = Top Assembly Drawing | GENERATED : 6/30/2017 | 5:44:48 PM | TEXAS INSTRUMENTS              |



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.  
 ASSEMBLY VARIANT: 001

|                                     |                                  |         |                                |
|-------------------------------------|----------------------------------|---------|--------------------------------|
| PCB VIEWED FROM BOTTOM SIDE         | BOARD #: TIDA-01428              | REV: E1 | SVN REV: Not In VersionControl |
|                                     | TID #: TIDA-01428                |         |                                |
| PLOT NAME = Bottom Assembly Drawing | GENERATED : 6/30/2017 5:44:50 PM |         | TEXAS INSTRUMENTS              |

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